Multilayer Ceramic Chip Capacitors

C1608X5R1H104K080AA





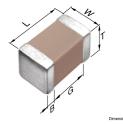


1 of 3 Creation Date : May 02, 2017 (GMT)



TDK item description C1608X5R1H104KT****

Applications	Commercial Grade Please refer to Part No. CGA3E2X5R1H104K080AA for Automotive use.	
Feature	General General (Up to 50V)	
Series	C1608 [EIA 0603]	
Status	Production (Not Recommended for New Design)	



Size		
Length(L)	1.60mm ±0.10mm	
Width(W)	0.80mm ±0.10mm	
Thickness(T)	0.80mm ±0.10mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	0.30mm Min.	
Recommended Land Pattern (PA)	0.70mm to 1.00mm(Flow Soldering)	
recommended Land Fattern (FA)	0.60mm to 0.80mm(Reflow Soldering)	
Recommended Land Pattern (PB)	0.80mm to 1.00mm(Flow Soldering)	
Neconimended Land Fattern (FB)	0.60mm to 0.80mm(Reflow Soldering)	
Recommended Land Pattern (PC)	0.60mm to 0.80mm(Flow Soldering)	
necommended Land Fattern (FC)	0.60mm to 0.80mm(Reflow Soldering)	

Electrical Characteristics		
Capacitance	100nF ±10%	
Rated Voltage	50VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	3%	
Insulation Resistance (Min.)	5000ΜΩ	

Other	
Soldering Method	Wave (Flow)
	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	4000pcs

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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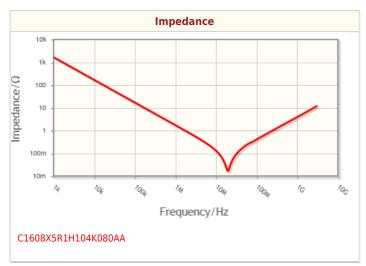


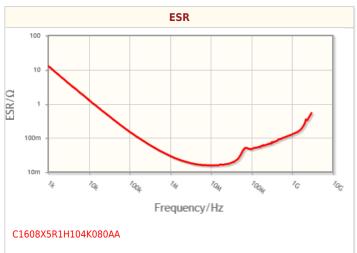


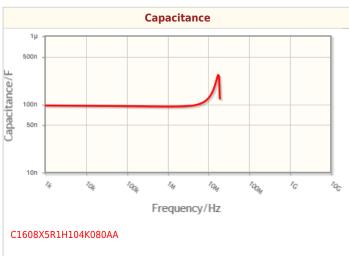


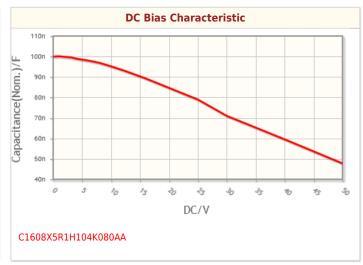


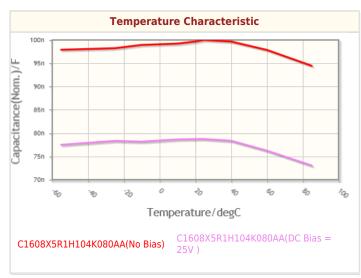
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

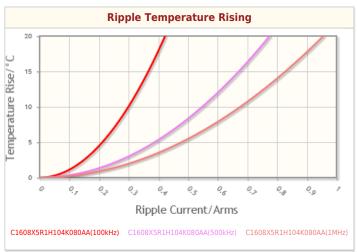












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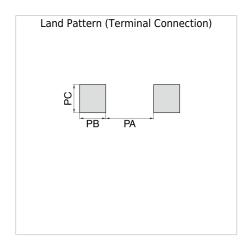








Associated Images



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